

Infineon XENSIVTM sensors At the forefront of the sensorization of things

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The future is here





Human Machine Co-existence



Generative AI and AR/VR



Smart homes



Intelligent and autonomous cars



Infineon sensors have applications in every industry



Smart home and building



- Activity recognition
- Attention monitoring

Retail, PoS, digital signage



- Traffic monitoring
- Attention monitoring
- Voice interface

Surveillance and safety



- Intrusion detection, alarm systems
- Safety systems, social distancing
- People counting, traffic monitoring

Smartphone



- Voice pick up, voice detection
- 3D authentication, AR

Notebooks, tablets, conferencing



- Audio communications
- Human presence, anti-peeking
- Augmented reality

Hearables and wearables



- Bio sensing
- Contextual awareness, AR/MR
- Voice UI, ANC, touch/gesture UI

Service robots



- Navigation
- Contextual awareness
- User interface

Car and mobility



- Occupancy monitoring
- Safety
- User interface



XENSIV™ consumer and industrial sensors



Touch sensors

Pressure and CAPSENSE™

CO₂-based gas sensor





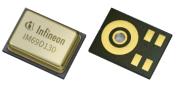








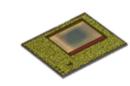
Microphones

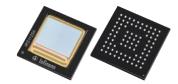




3D time-of-flight (ToF) camera

High resolution depth





3D RADAR technology













XENSIVTM microphones



High performance XENSIV™ microphones enable new audio use cases



Advanced audio functionality

Low self-noise to capture the faintest and far-field sounds

Enables **best-in-class** transparent hearing and active noise cancelling functionality

Low signal distortions even at high sound pressure levels

Handling of high signal peaks for reliable ANC performance



High SNR

High AOP









Robustness

Low power

consumption

Low part

variability

Ingress protection (IP57) and filters for **RF** suppression reduce integration cost and manufacturability

Ultra-low power digital microphones and selectable power modes for long-lasting battery life

> Tight sensitivity, phase and LFRO matching for beamforming applications and ANC control loop design







Automated speech recognition



Connecting the real to the digital world (for digital assistants, talk-to-text)

Active noise cancellation



Suppression of unwanted sounds (for advanced earbuds, headsets)

Beamforming and audio zoom



Changing audio recording directivity (for cameras, smart glasses, conference devices)

Transparent / Advanced hearing



Adaptive audio experience (for hearables and headphones)

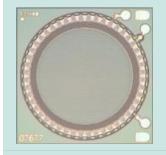


MEMS, ASIC and package: Building blocks of a MEMS microphone



Infineon Microphone System - Head Quarter in Munich, Germany

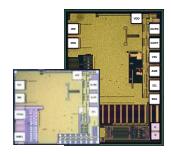
MEMS ASIC Package



Micro electro-mechanical system

Membrane and backplate forming a capacitor

Capacitor is modulated by acoustic waves



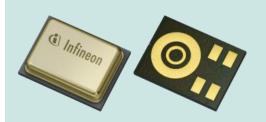
ASIC contains circuitry for MEMS

Charge pump for membrane

Amplifier stages

LDO for clean supply

Calibration logic



Package protects the device and enables pick-and-place

Shielding (EMI)

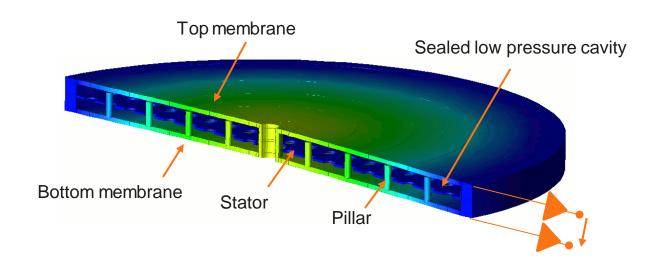
Package volume is forming an acoustical back volume

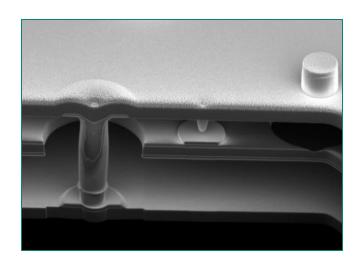
Infineon owns all building blocks of MEMS microphones – allowing to identify and develop MEMS, ASIC and package combinations optimized to each application



Infineon's sealed dual membrane technology is a revolutionary step forward for capacitive MEMS microphones







- True-differential topology
 - Enables ultra-high SNR of up to 75 dB SNR (80 dB for dual MEMS)
 - Distortion improvement by cancellation of even order distortion
- IP57 environmental robustness leads to less field returns and better manufacturability







XENSIVTM radar



Smart presence detection with Infineon radar sensors

Reducing energy consumption while improving user experience



Smart thermostats & displays



- Activation by proximity sensing
- Enhance booting time & user experience
- Support gesture control

Smart lighting systems



- Activate only where people are located
- Indoor & outdoor
- Higher sensitivity than PIR sensors

Room air conditioners



- Turn on & off devices based on presence
 & vacancy detection
- Steer airflow away from people's position

Security systems



- Start camera & recording only
 by movements inside the covered area
- Reduce number of false alarms

Laptops & monitors



- Turn off / reduce brightness by absence detection
- Increased battery lifetime
- Lock the screen to protect data

V



- Turn off screen by absence detection
- Pause & resume streaming content based on presence & absence





Radar solutions – Helping companies reduce carbon footprint

Number of smart homes worldwide will exceed 500 million by 2026.

Smart activation & deactivation based on radar presence & absence detection saves energy.

Radar sensors can add additional functionalities to increase comfort & safety in a smart environment.

Article: bit.ly/3CoMYUt

Radar sensor for smart devices – huge energy-saving potential

By using highly sensitive Infineon radar sensors¹, smart devices are able to detect the presence and absence of people. Thus, radar-supported smart devices can automatically switch between on mode and energy-saving deep sleep mode.



300 million smart home households worldwide in 20222

Assumption:
5 smart devices per household, equipped with radar sensors

Average energy savings per device per day = 100 Wh³ Energy-saving potential per household per day = 0.5 kWh

 Cumulative energysaving potential for 300 million smart households worldwide = 55 TWh per year

Annual energy production of 5,000 wind power turbines⁵



- 1 Infineon XENSIV™ 60 GHz radar sensor, www.infineon.com/60GHz
- 2 Source: Statista
- 3 Average out of a wide saving range. From a single watt (e.g. putting a device from stand-by to a deeper sleeping mode) to 100 watts and more (e.g. turning off a TV while nobody is in the room)

4 Assumption: 3-person household with 3,500 kWh energy consumption per year 5 Assumption: Average energy production of a wind turbine = 10 GWh





Portfolio that caters to all use cases



Increasing functionality

BGT60LTR11AIP		BGT60UTR11AIP	BGT60TR13C	
	G Astronomy Control of the Control o	S Infineon SCIENTIFICATION	G Infineon BGTGOTRIZC	
	6.7 x 3.3 mm	4.05 x 4.05 mm	6.5 x 5.0 mm	
Positioning	Smart & cost-effective PIR replacement	Compact and cost-efficient radar chip for FMCW operations	Enable advanced radar sensing including presence, tracking and gesture control	
Operating mode	Doppler Radar with integrated detectors	FMCW (5.5 GHz BW)	FMCW (5.5 GHz BW)	
Value proposition	Completely autonomous mode: Most convenient way to implement radar in your system	Smallest 60 GHz chip with integrated antennas on the market	Maximum functionality and flexibility: Develop the most demanding radar use cases	
Target use cases	Motion detection, Presence detection (short range)	Presence detection, gesture control, vital sensing, 1D ranging, material classification	Presence detection, gesture control, vital sensing, segmentation, tracking, distance	
Target applications	Lighting, monitors, TV, cameras, loT/smart-home applications, door openers, toilets,	Smart Home, Smart appliances, health care devices, TVs, laptops, Service robots,	Smartphones, laptops, smart home applications, health- & babycare devices,	





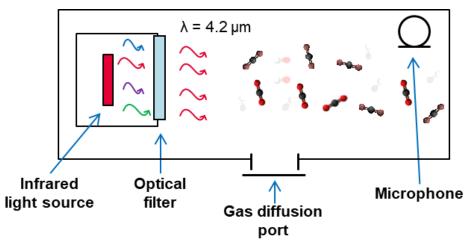
XENSIVTM CO2 sensors



Thanks to our leadership in MEMS technologies, we have realized a new generation of miniaturized CO₂ sensors



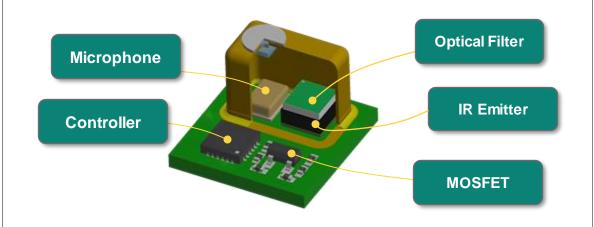
From photoacoustic spectroscopy principle...



The PAS principle allows for a direct, accurate and selective measurement of CO2

- A MEMS-based IR emitter generates a light pulse at a specific wavelength selective to CO2
- CO2 molecules absorb the light and vibrate, creating a sound wave with an amplitude directly related to the concentration
- The sound wave is detected by a MEMS microphone

...to mass produced XENSIV[™] PAS CO2 sensor



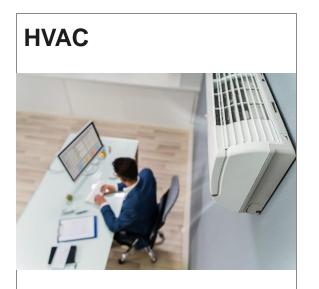
All key components are developed by Infineon

- The PAS CO2 sensor achieves the accuracy & stability
 of high-end NDIR CO2 sensors in a 4x smaller size
- Compliant with major standards and regulations for indoor air quality (e.g.: WELL, LEED, ASHRAE)
- Suitable for high volume standard assembly processes with surface mount assembly



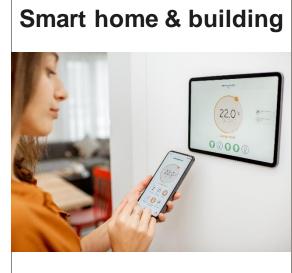
XENSIV™ PAS CO2 is targeting many applications for indoor air quality monitoring and energy saving













Air quality awareness



Higher comfort levels



Healthier life



Lower energy consumption



Increased productivity



Energy cost savings





CAPSENSE™ sensors

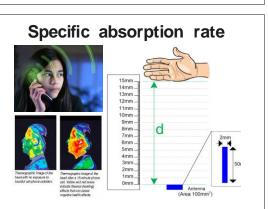






- Capacitive sensing has changed the face of the modern products and the way users interact with them
- CAPSENSE™ is Infineon's proprietary capacitive sensing technology used in touch user interfaces
- Replaced over 6+ Billion conventional buttons













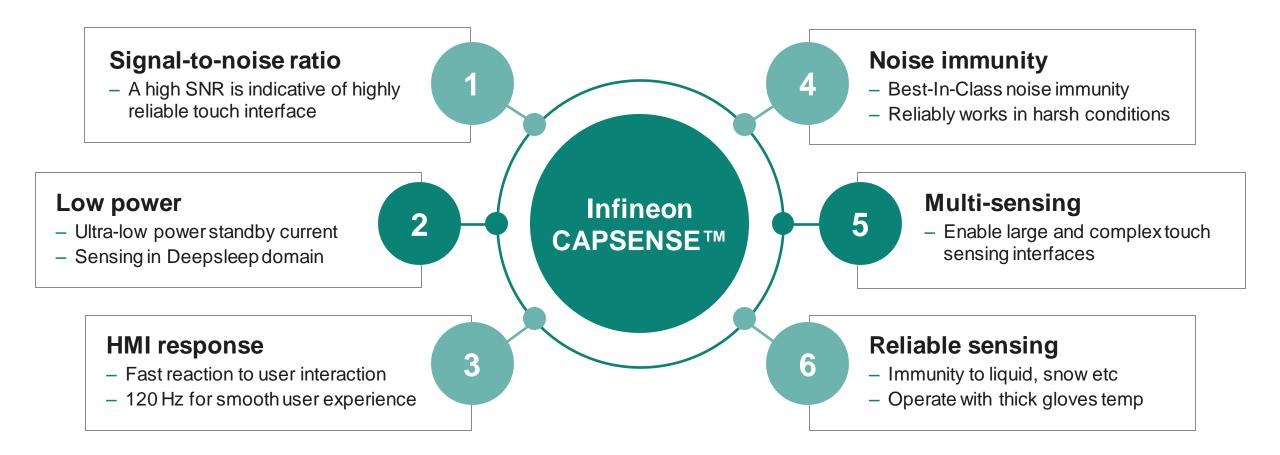






CAPSENSE™ touch-sensing technology









5th generation sensing technology – Multi sense converter

Feature	Higher SNR	Lower power	Higher refresh rate	Improved linearity	Supply rejection
Differential (rail-rail) sensing	\bigcirc				
Ratio metric sensing	\bigcirc				
Autonomous scanning					
Multi-channel			\bigcirc		
Dithering					
Full wave conversion (2x CMOD)					





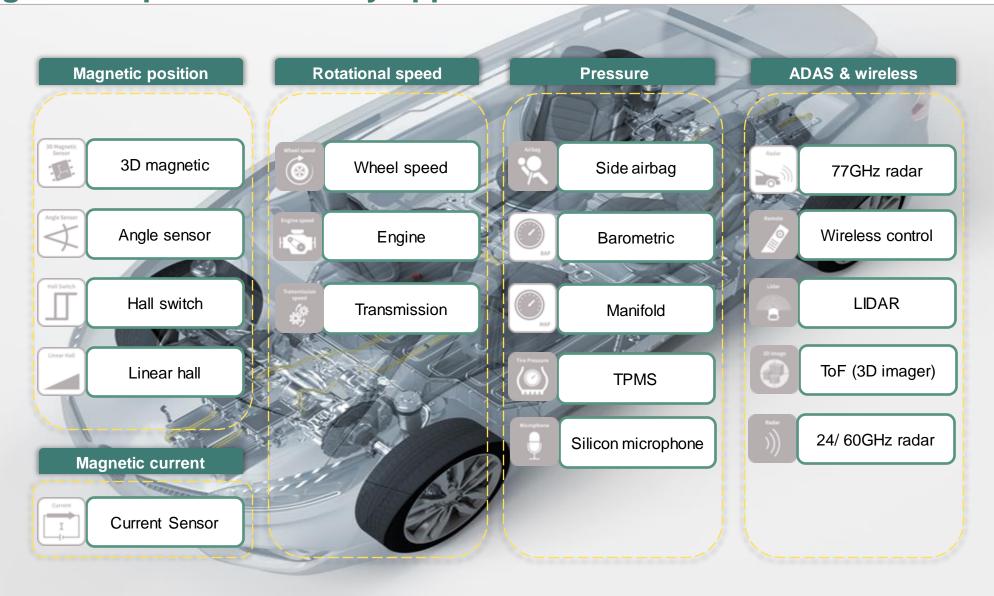
XENSIVTM automotive sensors





A broad sensor portfolio for automotive Leading market positions in key applications









From 'sensor' to 'sensor system solutions'



An holistic sensor systems approach is required to successfully create new use cases





Sensor and IC technology

Edge Al

Layers of analytics from sensor to cloud



Connectivity and security

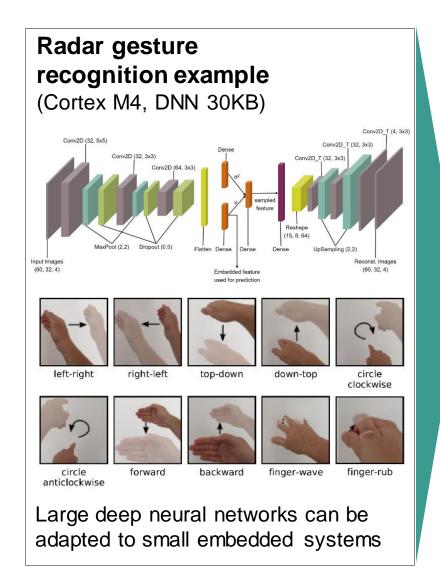
 Sensor technology, heterogeneous packaging, power management

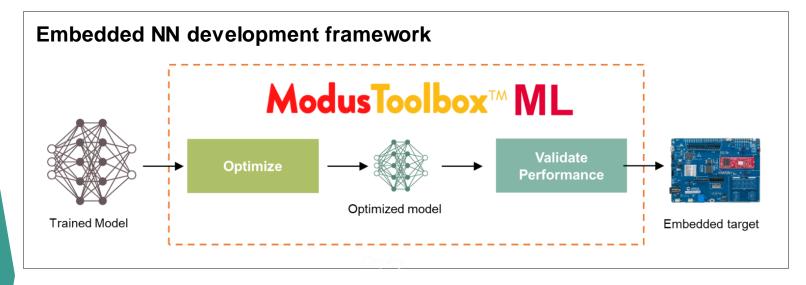
- Tools, DNN, edge NPU
- Runtimes,
 containerization, load
 balancing, OTA
- Interoperability, ease of use, reliability, energy efficiency

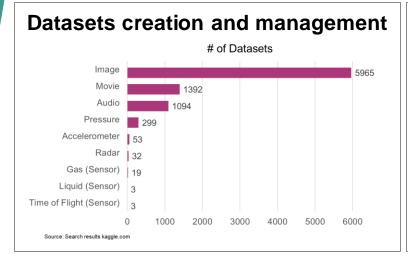


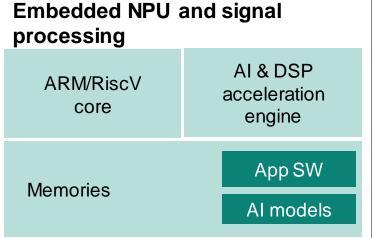
Edge analytics and Al













Layers of analytics from edge to cloud

Load balancing sensor-edge-hub-cloud



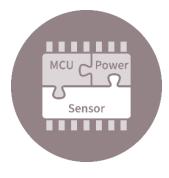
Complexity

Upgradability

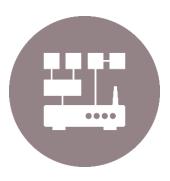
Data fusion

Flexibility

A critical business choice: cost of ownership, upgradability, energy consumption, user experience depend on it









- **Energy efficiency**
- Privacy
- Latency

can be moved dynamically



Interoperable connectivity & security frameworks (eg. Matter)

A mix of analytics layer which



OTA upgrades, Edge containerization runtime (incl. MCU)

Sensor system in action

XENSIV™ connected sensor kit (CSK)



